## TOSHIBA

TOSHIBA FIELD EFFECT TRANSISTOR SILICON N CHANNEL MOS TYPE

## 2 S K 2 8 2 3

FOR PORTABLE EQUIPMENT

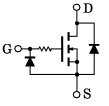
HIGH SPEED SWITCH APPLICATIONS

ANALOG SWITCH APPLICATIONS

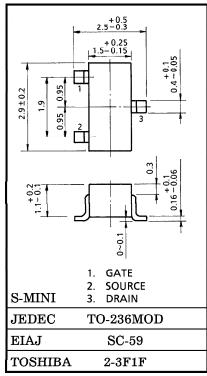
- High Input Impedance
- 1.5V Gate Drive
- Low Gate Threshold Voltage : Vth=0.5~1.0V
- Small Package

EQUIVALENT CIRCUIT

MARKING



KΚ



Weight : 0.012g (Typ.)

This transistor is electrostatic sensitive device. Please handle with caution.

## MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT	
Drain-Source Voltage	V <sub>DS</sub>	20	v	
Gate-Source Voltage	VGSS	10	v	
DC Drain Current	ID	100	mA	
Drain Power Dissipation	PD	200	mW	
Channel Temperature	T <sub>ch</sub>	150	°C	
Storage Temperature Range	T <sub>stg</sub>	$-55 \sim 150$	°C	

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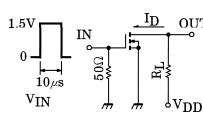
Unit in mm

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CHARAC	CTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Gate Leakage	Current	IGSS	$V_{GS} = 10V, V_{DS} = 0$	_		1	μA
Drain-Source I Voltage	Breakdown	V (BR) DSS	$I_{D} = 100 \mu A, V_{GS} = 0$	20	_	_	v
Drain Cut-off	Current	IDSS	$V_{DS}=20V, V_{GS}=0$	_	_	1	$\mu \mathbf{A}$
Gate Threshol	d Voltage	$v_{th}$	$V_{DS} = 1.5V, I_D = 0.1mA$	0.5		1.0	V
Forward Tran	sfer Admittance	Y <sub>fs</sub>	$V_{DS} = 1.5V, I_D = 10mA$	35	70		mS
Drain-Source ON Resistance $1 R_{DS(ON)1}$		$I_D=1mA$ , $V_{GS}=1.2V$	_	15	50	Ω	
Drain-Source	ON Resistance 2	$R_{DS}(ON) 2$	$I_D = 10 \text{mA}, V_{GS} = 1.5 \text{V}$	_	10	40	Ω
Drain-Source	ON Resistance 3	R <sub>DS</sub> (ON) 3	$I_D = 10 \text{mA}, V_{GS} = 2.5 \text{V}$	_	7	28	Ω
Input Capacita	ance	Ciss	$V_{DS} = 1.5V, V_{GS} = 0, f = 1MHz$	_	12		pF
Reverse Transfer Capacitance C <sub>rss</sub>		$V_{DS} = 1.5V, V_{GS} = 0, f = 1MHz$	_	3.4	_	pF	
Output Capaci	itance	Coss	$V_{DS} = 1.5V, V_{GS} = 0, f = 1MHz$		12		pF
Switching	Turn-on Time	t <sub>on</sub>	V <sub>DD</sub> =1.5V, I <sub>D</sub> =10mA,		0.35		
Time	Turn-off Time	toff	$V_{GS} = 0 \sim 1.5 V$	_	0.2	_	$\mu s$

ELECTRICAL CHARACTERISTICS (Ta = 25°C)

## SWITCHING TIME TEST CIRCUIT





 $\begin{array}{c} \underset{\scriptstyle 0 \text{UT}}{\overset{\scriptstyle 0 \text{UT}}{\longrightarrow}} & \underset{\scriptstyle 0 \text{UL}}{\overset{\scriptstyle 0 \text{UD}}{\longrightarrow}} = 1.5 \text{V} \\ & \underset{\scriptstyle 0 \text{UL}}{\overset{\scriptstyle 0 \text{UL}}{\longrightarrow}} = 1.5 \text{V} \\ & \underset{\scriptstyle 0 \text{UL}}{\overset{\scriptstyle 0 \text{UI}}{\longrightarrow}} = 1.5 \text{V} \\ & \underset{\scriptstyle 0 \text{VIN}}{\overset{\scriptstyle 0 \text{VIN}}{\longrightarrow}} : t_{r}, t_{f} < 5 \text{ns} \\ & \underset{\scriptstyle (\text{Z}_{out} = 50 \Omega)}{\overset{\scriptstyle 0 \text{COMMON SOURCE}}{\longrightarrow}} \\ & \underset{\scriptstyle \text{Ta} = 25^{\circ} \text{C}}{\overset{\scriptstyle 0 \text{C}}{\longrightarrow}} \end{array}$ 

